



## Material Content Data Sheet



Halogen-Free

Sales Product Name	IPS60R1K0CE	Issued	25. June 2021
MA#	MA005558487		
Package	PG-TO251-3-343	Weight*	339.94 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.144	0.63	0.63	6306	6306
leadframe	inorganic material	phosphorus	7723-14-0	0.055	0.02		163	
	non noble metal	iron	7439-89-6	0.185	0.05		544	
	non noble metal	copper	7440-50-8	184.668	54.33	54.40	543240	543947
wire	non noble metal	aluminium	7429-90-5	0.555	0.16	0.16	1632	1632
encapsulation	organic material	carbon black	1333-86-4	0.726	0.21		2137	
	plastics	epoxy resin	-	19.615	5.77		57700	
	inorganic material	silicondioxide	60676-86-0	124.952	36.76	42.74	367573	427410
leadfinish	non noble metal	tin	7440-31-5	4.771	1.40	1.40	14034	14034
solder	non noble metal	tin	7440-31-5	0.045	0.01		133	
	noble metal	silver	7440-22-4	0.057	0.02		167	
	non noble metal	lead	7439-92-1	2.166	0.64	0.67	6371	6671
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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